

MA3S781 (MA781)

Silicon epitaxial planar type

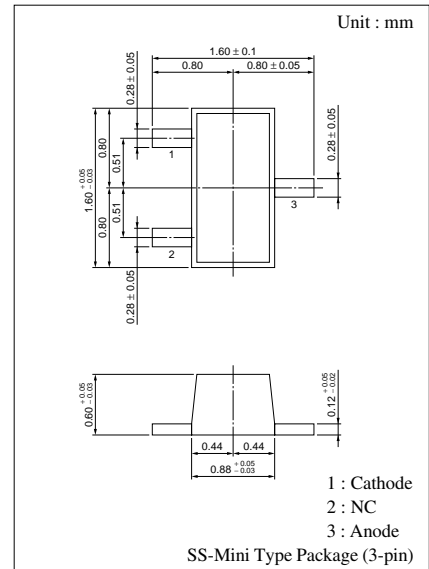
For the switching circuit

■ Features

- 1608 type diode contained in the (SS-mini) package
- Surface mounting, allowing high-density mounting
- Optimum for high-frequency rectification because of its short reverse recovery time (t_{rr})
- Low V_F (forward rise voltage), with high rectification efficiency

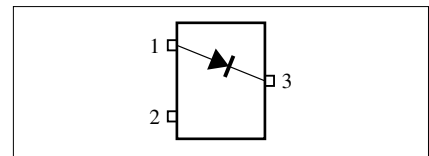
■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Reverse voltage (DC)	V_R	30	V
Peak reverse voltage	V_{RM}	30	V
Forward current (DC)	I_F	30	mA
Peak forward current	I_{FM}	150	mA
Junction temperature	T_j	125	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +125	$^\circ\text{C}$



Marking Symbol: M1L

Internal Connection



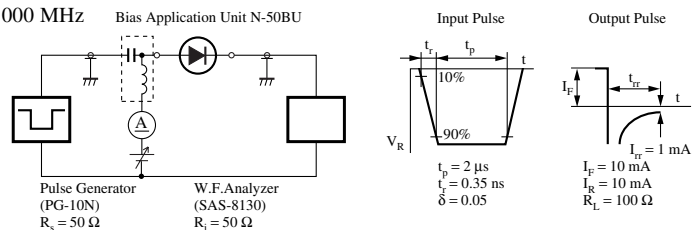
■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse current (DC)	I_R	$V_R = 30\text{ V}$			300	nA
Forward voltage (DC)	V_{F1}	$I_F = 1\text{ mA}$			0.4	V
	V_{F2}	$I_F = 30\text{ mA}$			1	V
Terminal capacitance	C_t	$V_R = 1\text{ V}, f = 1\text{ MHz}$		1.5		pF
Reverse recovery time*	t_{rr}	$I_F = I_R = 10\text{ mA}$ $I_{rr} = 1\text{ mA}, R_L = 100\ \Omega$		1.0		ns
Detection efficiency	η	$V_{in} = 3\text{ V (peak)}, f = 30\text{ MHz}$ $R_L = 3.9\text{ k}\Omega, C_L = 10\text{ pF}$		65		%

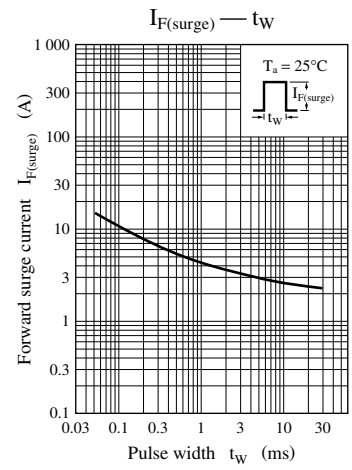
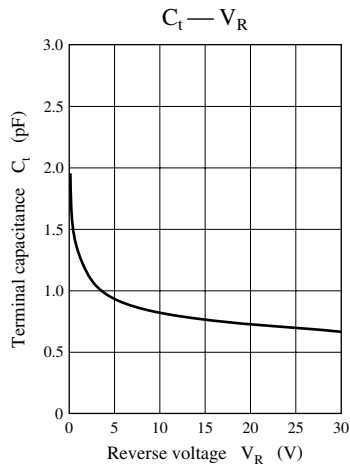
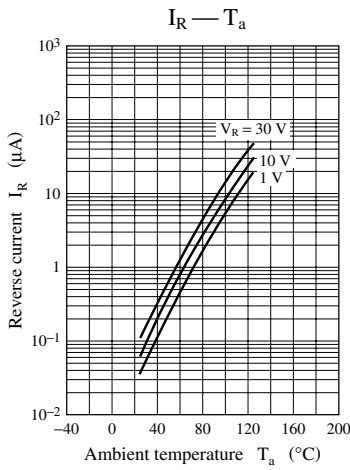
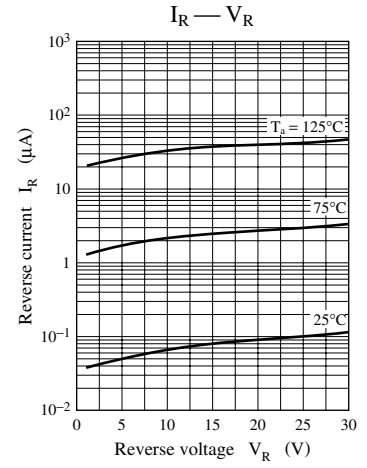
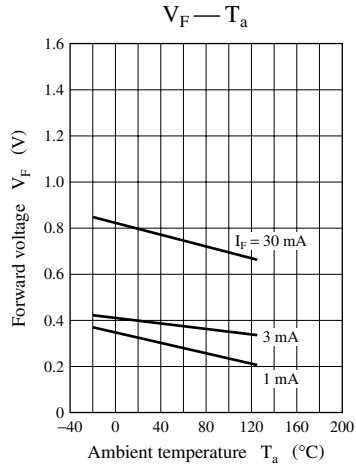
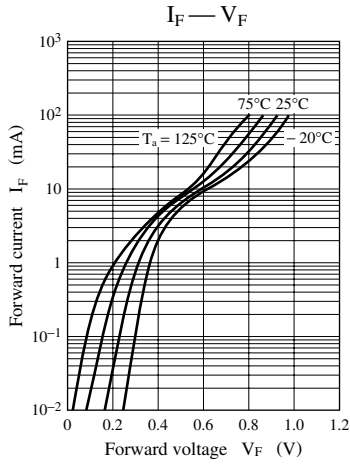
Note) 1. Schottky barrier diode is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

2. Rated input/output frequency: 2 000 MHz Bias Application Unit N-50BU

3. *: t_{rr} measuring circuit



Note) The part number in the parenthesis shows conventional part number.



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